

FYLS-0805UWC

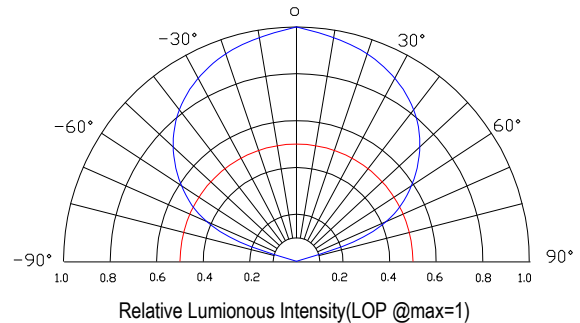
Features:

- Compatible with automatic placement equipment
- Compatible with reflow solder process.

Applications:

- Automotive-Telecommunication
- Indicators
- LCD Back-lights
- Illuminations

Radiation pattern.



Descriptions:

- Dice material: InGaN.
- Emitting Color: White
- Lens Color: Water clear

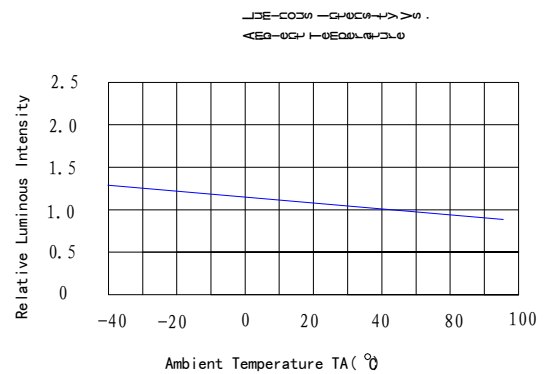
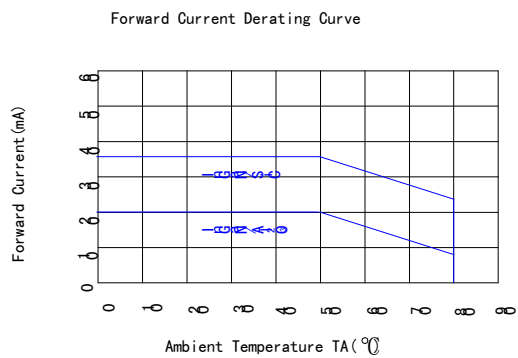
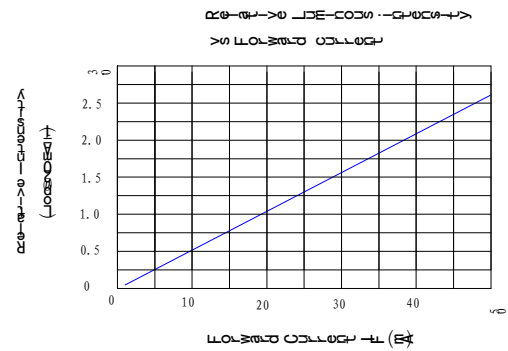
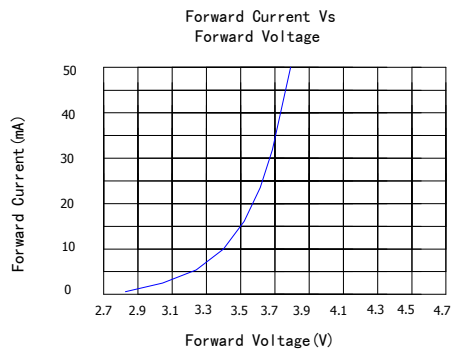
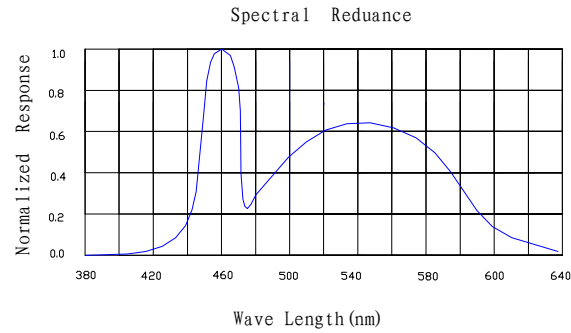
Absolute maximum ratings (Ta=25 °c)

Parameter	MAX.	Unit
Power Dissipation	70	mW
Peak Forward Current (1/10 Duty Cycle, 0.1ms Pulse Width)	100	mA
Continuous Forward Current	25	mA
Derating Linear From 25°C	0.4	mA/°C
Operating Temperature Range	-30°C to +80°C	
Storage Temperature Range	-40°C to +100°C	
Lead Soldering Temperature[4mm(.157") From Body]	260°C for 5 Seconds	

Electrical and optical characteristics(Ta=25 °c)

Parameter	Symbol	Min.	Typ.	Max.	Unit	Test Condition
Luminous Intensity	IV	–	550	–	mcd	IF= 20mA
Viewing Angle	2θ1/2	120	130	140	Deg	
Chromaticity coordinate	x		0.31			
	y		0.31			
Color Temperature	CCT	5000	7000	9000	K	
Forward Voltage	VF	2.8	3.0	3.4	V	VR=5V
Reverse Current	IR			10	μA	

Typical Electrical Characteristics Curves (25 °c Ambient Temperature Unless Otherwise Noted)



◆ Precautions For Use

1. Suggest the LEDs should be kept between 5°C and 30°C and 60%RH or less before opening the package, The max. storage period before opening the package is 1 year.
2. After opening the package, the LEDs should be kept at 30°C/35%RH or less, and it should be used within 3 hours. In the event of incomplete usage, it is advised that user preheat the remaining devices at 60±5°C for 8 hours prior to use.
3. Reflow soldering should not be done more than twice. When soldering, don't stress on LEDs during heating. After soldering, don't warp the circuit board.
4. Repair should not be done after the LEDs have been soldered. When repair is unavoidable, Double-head soldering iron should be used. It should be confirmed beforehand whether the characteristics of the LEDs will be damaged by repair or not.

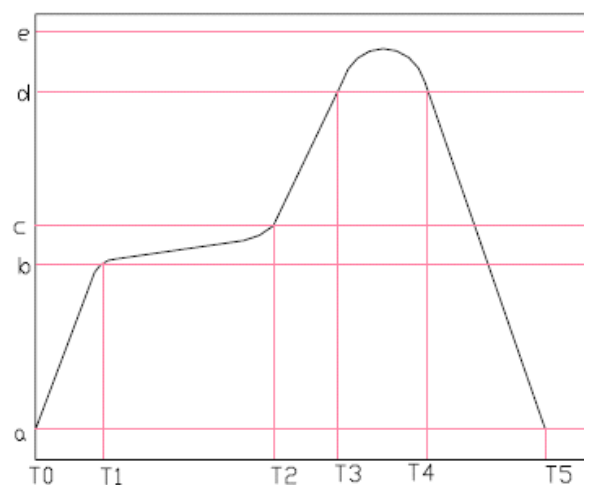
◆ Soldering Iron:

- Temperature at tip of iron: 300 °C Max. (25W Max)
- Soldering time: 3±1sec.

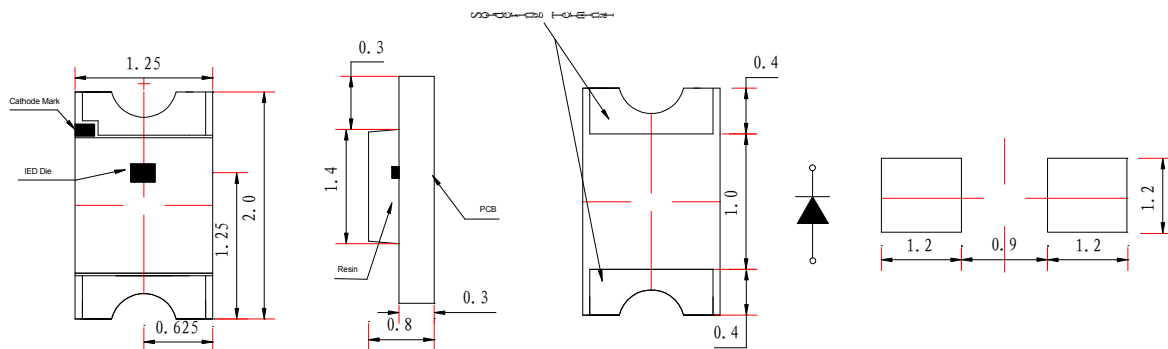
◆ Reflow Temp./Time:

Please refer to the following figure :

Temp.(°C)		Time(Sec)	
a	25	T0~T1	Max. 3°C/sec
b	150	T1~T2	90~130 sec
c	200	T2~T3	Max. 3°C/sec
d	220	T3~T4	Max. 30~50 sec
e	250		
		T4~T5	Max. -3°C/sec
Blet Speed		70~90 cm/min	



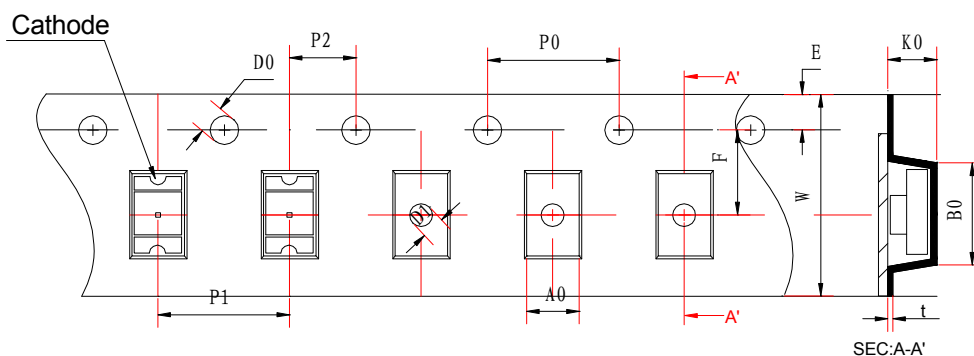
◆ Package Dimensions of Device



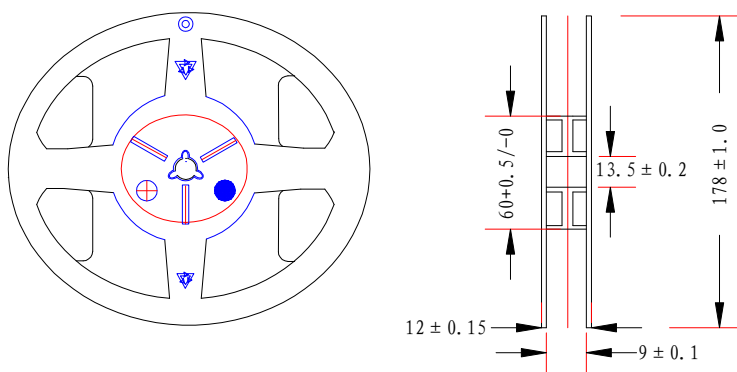
Unit:mm

◆ Tape Specification: 4000pcs Per Reel.

Packing Size								
Item	W	P1	E	F	D0	D1	P0	Unit
Spec.	8.00	4.00	1.75	3.50	1.50	1.0	4.00	mm
Tolerance	±0.20	±0.10	±0.10	±0.05	+0.1/-0	±0.05	±0.05	mm
Item	10P0	P2	A0	B0	K0	T		Unit
Spec.	40.00	2.00	1.40	2.25	1.1	0.23		mm
Tolerance	±0.20	±0.05	±0.10	±0.10	±0.10	±0.05		mm



◆ Package Dimensions of Reel:



Unit:mm

◆ Packing and Shipping Spec.

